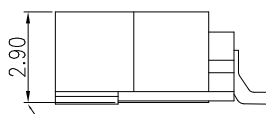


MATERIALS

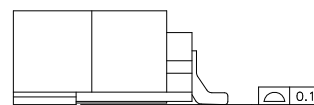
Insulator :High temperature plastic,UL94V-0
 Contact :Copper Alloy
 Contact Plating :Gold flash or Tin over Nickel 30~120u"
 (See Part no.):

Solder Plating
 SPECIFICATONS

Current Rating :1A
 Operation Temperature :-25°C to +85°C
 Insulation Resistance :500MΩ Min
 contact resistance :20mΩ Max
 Processing Temperature :260°C for 10 seconds



Drawing for 17lin~18PIN



PART NO.:

1 W 1C 004 T ** C * * 0 00

00=RoHS
 HF=HALOGEN FREE

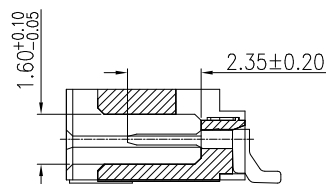
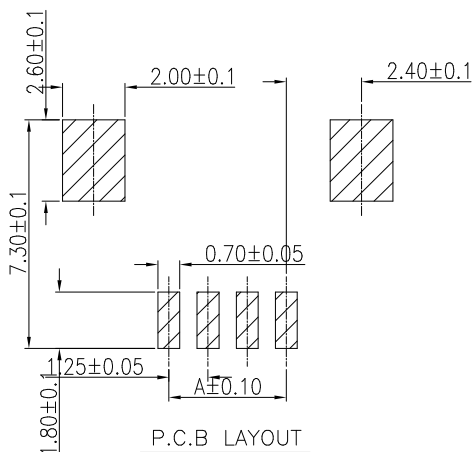
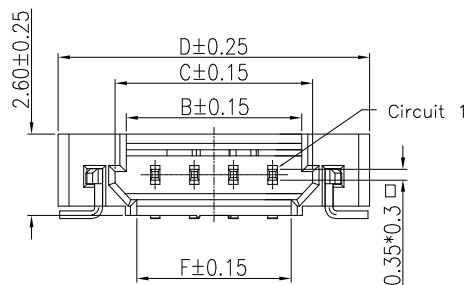
PACKING
 P=BAG
 1=TUBE
 2=TAPE&REEL WITH MYLAR
 3=TAPE&REEL
 4=TAPE&REEL WITH CAP(PA6T)

Code
 001
 002
 003

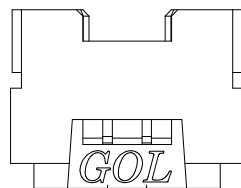
Plating
 T=Tin 80~200u"
 U=Gold Flash
 H=Gold 3u"Min
 E=Gold 5u"Min

To From
 C=BEND SMT(R/A)

NO.OF CONTACTS
 02=2PIN
 03=3PIN
 10=10PIN



SEC:A-A



2PIN

18	21.25	22.83	23.81	27.45	5.00	22.43
17	20.00	21.58	22.56	26.20	5.00	21.18
16	18.75	20.33	21.31	24.95	5.00	19.93
15	17.50	19.08	20.06	23.70	5.00	18.68
14	16.25	17.83	18.81	22.45	5.00	17.43
13	15.00	16.58	17.56	21.20	5.00	16.18
12	13.75	15.33	16.31	19.95	5.00	14.93
11	12.50	14.08	15.06	18.70	5.00	13.68
10	11.25	12.83	13.81	17.45	3.50	12.43
09	10.00	11.58	12.56	16.20	3.50	11.18
08	8.75	10.33	11.31	14.95	3.50	9.93
07	7.50	9.08	10.06	13.70	3.50	8.68
06	6.25	7.83	8.81	12.45	3.50	7.43
05	5.00	6.58	7.56	11.20	3.50	6.18
04	3.75	5.33	6.31	9.95	3.50	4.93
03	2.50	4.08	5.06	8.70	3.50	3.68
02	1.25	2.83	3.81	7.45	3.50	2.43
PIN 数	A	B	C	D	E	F

GENERAL TOLERANCE	DRAWN	VICENT.YAO	09'11/16	SCALE	PART NO.	1W1C004T**C*30**
X.±0.30	x.'±3'	CHECKED	RYAN.LAI	4/1	TITLE	1.25 PITCH R/A SMT WAFER CONN
.X±0.25	.x'±2'	APPROVED	RAY LEE	UNITS	mm	CUSTOMER DRAWING
.XX±0.20		File NO.	W1C00402S			
.XXX±0.10		REV.				
SHEET	1/1	Q'TY	1	A	蘇州祥龍嘉業電子科技股份有限公司 Goldenconn Electronics Technology Co.,LTD	